

PSRP25 Series

PSRP 2512 Series-Prosemi Shunt Resistors

Features

- Metal Alloy Low-Resistance shunt resistor.
- Resistance value 0.3Ω , $0.5m\Omega$, $1m\Omega$, $2m\Omega$, $3m\Omega$, $4m\Omega$.
- Low thermal EMF.
- Low TCR.
- Very low inductance.
- Halogen free, lead free and RoHS compliant.

Applications

- Power modules.
- Frequency converters.
- Current sensor for power hybrid sources high current for automotive.
- Lithium battery protection board.

Part Number

<u>PSRP 25 S 6 F R50</u>

[1] [2] [3] [4] [5] [6]

- [1] Series Name: Prosemi Shunt Resistor for High Power Applications.
- [2] Chip Size: 25: 2512,
- [3] Material: S: CuMnSn, M: CuMn, K: NiCr , C: Ni & Sn plated Copper.
- [4] Power Rating: 6=6W, 4=4W, J=Jumper.
- [5] Resistance Precision: D: ±0.5%, F: ±1%, J: ±5%, 0: Jumper.
- [6] Resistance Code: R00: Jumper, R30: 0.3mΩ, 1R0: 1mΩ.

Electrical Characteristics

Size	Power Rating at 70℃(W)	Resistance Range (mΩ) [*] ±0.5%; ±1%; ±5%	Element TCR (ppm/℃)	Operation Temperature Range	Product temperature coefficient (ppm/°C)
2512	6	0.3~2	±30	-55℃~+150℃	± 250 for 0.3 m Ω and 0.5 m Ω ± 200 for 1m Ω
	4	3~4	100	00 00 1100 0	\pm 75 for 2~4 m Ω
	I _{max} =100A	Jumper	-	-	-

"*" : Other values may be available, contact factory

Note:

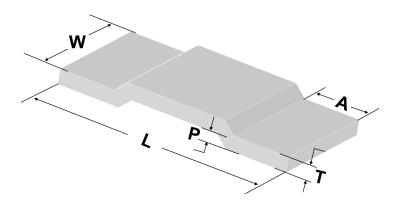
1) Ir = $(P/R)^{1/2}$ R: Resistance Value Ir: Rating Current P: Rating Power;

2) Product temperature coefficient: Includes the TCR effects of the resistor element and the copper terminal.



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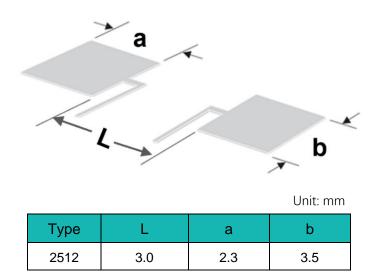
Physical Dimensions



Unit: mm

Size	Resistance (mΩ)	L	W	т	А	Р	Element Material	
	Jumper			-	1.53±0.2		Ni & Sn plated Copper	
	0.3			0.95±0.1			CuMn	
	0.5			0.4±0.1			CuMnSn	
2512	1	6.4±0.2	3.2±0.2	0.3±0.1		0.4±0.1	CuMn	
	2			0.5±0.1				NiCr
	3	3 4		0.3±0.1			NiCr	
	4			0.25±0.1			NiCr	

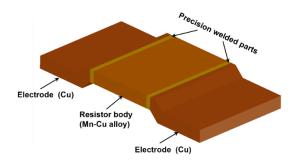
Recommended Solder Pad Layout





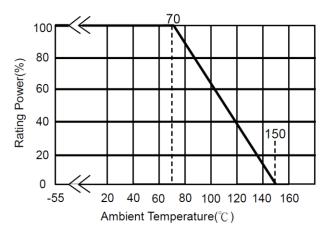
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Construction

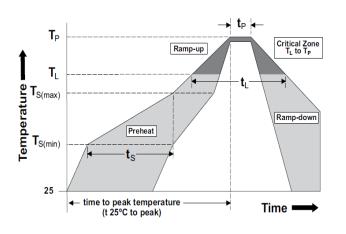


Power Derating Curve

For resistors operated in ambient temperatures 70°C, power rating shall be derated in according with the curve below:



Recommended Solder Curve



Reflow Condit	ion	Pb – Free assembly	
	- Temperature Min (T _s (min))	150°C	
Pre heat	- Temperature Max (T _s (max))	200°C	
	- Time (Min to Max) (ts)	60 – 120 secs	
	ramp up rate (Liquidus emp (T∟) to peak	5°C/second max	
T _s (max)	to T _L - Ramp-up Rate	5°C/second max	
Reflow	- Temperature (T∟) (Liquidus)	217°C	
	- Time (t _L)	60 – 150 seconds	
Peak	Temperature (T _P)	260°C	
-	within 5°C of actual k Temperature (t _p)	20 – 40 seconds	
R	amp-down Rate	5°C/second max	
Time 25°C f	to peak Temperature (T _P)	8 minutes Max.	
V	Vave Soldering	Not applicable	
ŀ	land Soldering	350°C, 5 seconds max.	



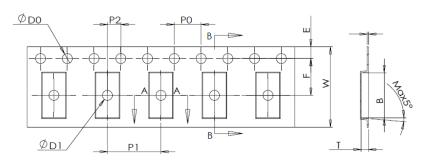
Product Characteristics

Item	Test condition/ Methods	Limited	Standard
Resistance	Measuring resistance value at room temperature 25℃±5℃	Refer to Spec	IEC60115-1 4.5
Temperature coefficient of resistance	TCR =(R-R ₀)/R ₀ (T ₂ -T ₁)X 10 ⁶ R ₀ : resistance of room temperature R: resistance of 125 °C T ₁ : Room temperature T ₂ : Temperature at 125 °C	Refer to Spec	MIL-STD-202 Method 304
Short time Overload	5 times the rated power for 5 seconds	≤±0.5%	MIL-R-26E
Resistance to Soldering Heat	Resistance to Soldering 260°C±5°C time: 12sec± 0.5sec		MIL-STD-202 Method 210
Temperature Cycling	ture Cycling -55℃ (15min)/+150℃(15min), 1000 cycles		MIL-STD-202 Method107G
Low temperature Storage	-55 °C for 24 h	≤±0.5%	MIL-STD-26E
High Temperature Storage	150 $^\circ\!\!\!\!\!^{\rm C}$ for 1000hours, No power	≤±1%	IEC6011501- 4.25
Bias Humidity	Bias Humidity +85℃,85% RH,10%bias, 1000hours		MIL-STD-202 Method103
Mechanical shock Condition C ,100 g's ,6 msec, 3 mutually perpendicular axes, in 6 directions, three impacts each for a total of 18 times 18 shocks.		≤±0.5%	MIL-STD-202 Method 213
The frequency varies from 10HZ to 55HZ and return to 10HZ, shall be transferred in 1 min. Amplitude : 1.5mm, 3 directions, and 12 hours		≤±0.5%	MIL-STD-202 Method 201
Operational life	70℃±2℃, 1000 hours, at rated power 1.5 hours "ON", 0.5 hours "OFF"	≤±1%	MIL-STD-202 Method 108
MiL-STD-202,method106, No power, 7b not required.		≤±0.5%	MIL-STD-202 Method 106



Packaging

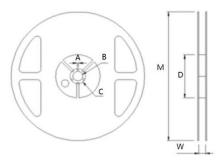
Tape Dimensions



Unit: mm

Туре	А	В	D0	Е	F	φD1
0.3mΩ	3.60±0.10	6.70±0.10	1.50+0.10	1.75±0.10	5.50±0.05	1.50±0.10
0.5~4mΩ	3.50±0.10	6.74±0.10	1.50+0.10	1.75±0.10	5.50±0.05	1.50±0.10
Туре	W	P0	P1	P2	Т	
0.3mΩ	12.00±0.30	4.00±0.10	8.00±0.10	2.00±0.05	1.60±0.10	
0.5~4mΩ	12.00±0.30	4.00±0.10	8.00±0.10	2.00±0.05	1.10±0.10	

Reel Dimensions



Unit: mm

Series	Туре	W (mm)	M (mm)	A (mm)	B (mm)	C (mm)	D (mm)
2512	7' reel	13.8±0.5	178.0±2.0	2.0±0.5	13.5±0.5	21.0±0.5	80.0±1.0

Quantity of Package

Туре	Quantity (pcs)	
0.3mΩ	1000	
0.5 \sim 4m Ω	2000	

Storage

1. The temperature condition must be controlled at $25\pm5^{\circ}$ C, The R.H. must be controlled at

 $60\pm15\%$ Store in accordance with this requirement, and the validity period is two years after

the date of manufacture.

- 2. Please avoid the mentioned harsh environment below when storing to ensure product performance and its' weldability. Places exposed to sea breeze or other corrosive gas, such as Cl₂, H₂S, NH₃, SO₂ and NO₂.
- When the product is moved and stored, please ensure the correct orientation of the box. Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.